

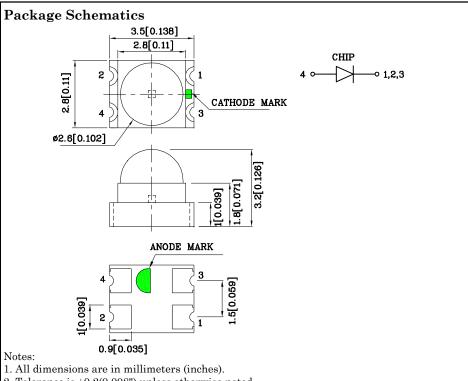
Part Number: ZMDK45W50MAV-6

3.5 x2.8mm SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package: 500pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant





2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.

3. Specifications are subject to change without notice.

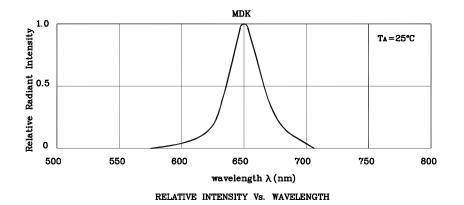
Absolute Maximum Ratings (T _A =25°C)		MDK (AlGaInP)	Unit	
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	$I_{\rm F}$	50	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	185	mA	
Power Dissipation	\mathbf{P}_{D}	130	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	$-40 \sim +85$	-0	

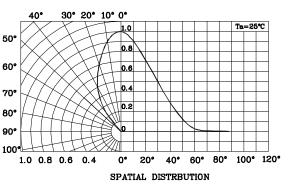
Operating Characteristics (T _A =25°C)		MDK (AlGaInP)	Unit	
Forward Voltage (Typ.) (I _F =50mA)	V_{F}	2.1	V	
Forward Voltage (Max.) (I _F =50mA)	V_{F}	2.6	V	
Reverse Current (Max.) (V _R =5V)	I_R	10	uA	
Wavelength of Peak Emission (Typ.) (I _F =50mA)	λP	650	nm	
Wavelength of Dominant Emission (Typ.) (I _F =50mA)	λD	630	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =50mA)	$ riangle\lambda$	28	nm	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	35	$_{\rm pF}$	

min. typ.	Part Number	Emitting Color	Emitting Material	Lens-color	Inter (I _F =5	inous nsity 0mA) cd	Wavelength nm λP	Viewing Angle 20 1/2
ZMDK45W50MAV-6 Red AlGaInP Water Clear 1200 1890 650 60°					min.	typ.		
	ZMDK45W50MAV-6	Red	AlGaInP	Water Clear	1200	1890	650	60°

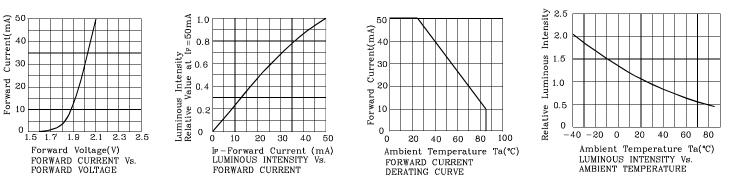
SDSA8218 V1 Layout: Maggie L.







♦ MDK



LED is recommended for reflow soldering and soldering profile is shown below.

300 (°C) 10 s max iner? 250 4°C/s C/s max 200 150~180 4°C/s max 150 Temperature 30~50s 60~120s 100 50 0 150 0 50 100 200 250 300 (sec) Time Notes:

Reflow Soldering Profile for SMD Products (Pb-Free Components)

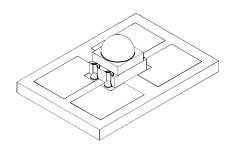
1. Maximum soldering temperature should not exceed 260°C

2. Recommended reflow temperature: 145°C-260°C 3. Do not put stress to the epoxy resin during

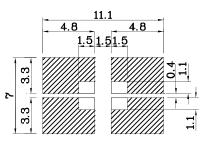
high temperatures conditions



✤ The device has a single mounting surface. The device must be mounted according to the specifications.

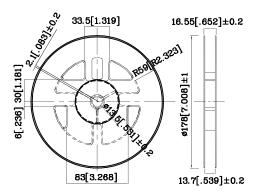


Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

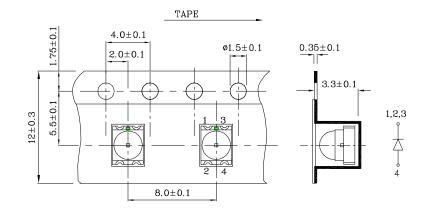


 \boxtimes Solder resist

Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS

